SN75124 TRIPLE LINE RECEIVER

SLLS058B - SEPTEMBER 1973 - REVISED MAY 1995

)	Meets or Exceeds the Requirements of IBM™ System 360 Input/Output Interface		PACKAGE VIEW)
	Specification		7 1
	Operates From Single 5-V Supply	1A 🛛 1	
	TTL Compatible	1B 🛛 2	15 🛛 1S
	-	2R 🛽 3	14 🛛 1R
	Built-In Input Threshold Hysteresis	2S 🚺 4	13 🛛 1Y
	High Speed Typical Propagation Delay	2A 🛛 5	12 🛛 3A
	Time = 20 ns	2B 🚺 6	11 🛛 3S
	Independent Channel Strobes	2Y 🛛 7	10 🛛 3R
	Input Gating Increases Application	GND 🛿 8	9 🛛 3Y
	Flexibility		

- Designed for Use With Dual Line Driver SN75123
- Designed to Be Interchangeable With Signetics N8T24

description

The SN75124 triple line receiver is specifically designed to meet the input/output interface specifications for IBM System 360. It is also compatible with standard TTL logic and supply voltage levels.

The SN75124 has receiver inputs with built-in hysteresis to provide increased noise margin for single-ended systems. An open line affects the receiver input as does a low-level input voltage, and the receiver input can withstand a level of -0.15 V with power on or off. The other inputs are in TTL configuration. The S input must be high to enable the receiver input. Two of the line receivers have A and B inputs that, if both are high, hold the output low. The third receiver has only an A input that, if high, holds the output low.

See the SN751730 for new IBM 360/370 interface designs.

The SN75124 is characterized for operation from 0°C to 70°C.

	FU		ADLE	
	OUTPUT			
Α	в†	R	S	Y
Н	Н	Х	Х	L
х	Х	L	Н	L
L	Х	Н	Х	н
L	Х	Х	L	н
х	L	Н	Х	н
Х	L	Х	L	н

FUNCTION TABLE

[†]B input and last two lines of the function table are applicable to receivers 1 and 2 only.



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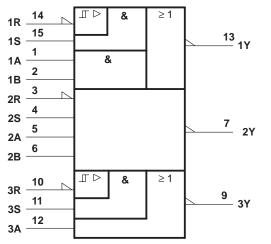
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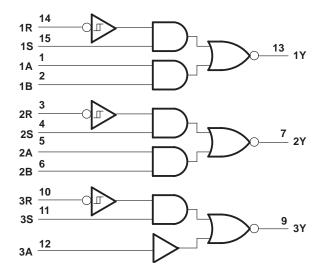
logic symbol[†]

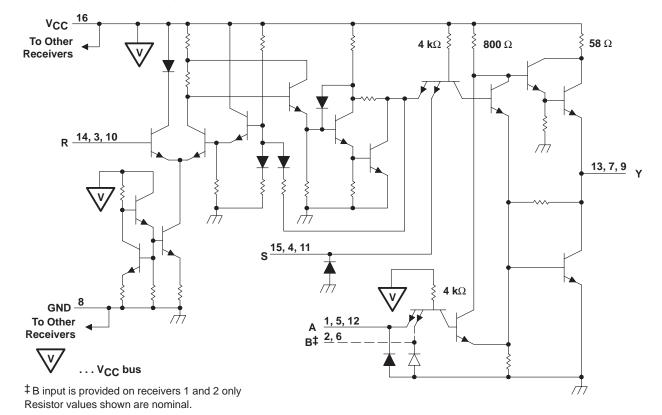


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematic (each receiver)

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Input voltage, VI: R input with V _{CC} applied	
R input with V _{CC} not applied	
A, B, or S input	5.5 V
Output voltage, V _O	
Output current, IO	±100 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: Voltage values are with respect to network ground terminal

DISSIPATION RATING TABLE									
PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING						
D	950 mW	7.6 mW/°C	608 mW						
N	1150 mW	9.2 mW/°C	736 mW						

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High-level input voltage, VIH	A, B, or S	2			V
High-level liput voltage, vH	R	1.7			V
Low-level input voltage, VIL	A, B, or S			0.8	V
Low-level input voltage, vil	R			0.7	V
High-level output current, IOH				-800	μA
Low-level output current, IOL				16	mA
Operating free-air temperature,	ГА	0		70	°C



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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	MIN	TYP	MAX	UNIT
V _{hys}	Hysteresis voltage (VIT + - VIT -)	R	V _{CC} = 5 V,	$T_A = 25^{\circ}C$	0.2	0.5		V
VIK	Input clamp voltage	A, B, or S	V _{CC} = 5 V,	l _l – 12 mA			-1.5	V
V _{I(BR)}	Input breakdown voltage	A, B, or S	$V_{CC} = 5 V,$	lı = 10 mA	5.5			V
VOH	High-level output voltage		$V_{IH} = V_{IH}$ min, I _{OH} = -800 µA,	V _{IL} = V _{IL} max, See Note 2	2.6			V
VOL	Low-level output voltage		$V_{IH} = V_{IH}min,$ $I_{OL} = 16 mA,$	V _{IL} = V _{IL} max, See Note 2			0.4	V
1.	Input ourrent of povinum input voltogo	R	V _I = 7 V				5	
Ц	Input current at maximum input voltage	ĸ	V _I = 6 V,	ACC = 0			5	mA
	High lovel input ourrent	A, B, or S	V _I = 4.5 V				40	A
IН	High-level input current	R	V _I = 3.11 V				170	μA
۱ _{IL}	Low-level input current	A, B, or S	V _I = 0.4 V,	V _{IR} = 0.8 V	-0.1		-1.6	mA
IOS	Short-circuit output current [†]				-50		-100	mA
100	Supply ourrent		All inputs = 0.8 V			72	mA	
ICC	Supply current	All inputs = 2 V				100	ШA	

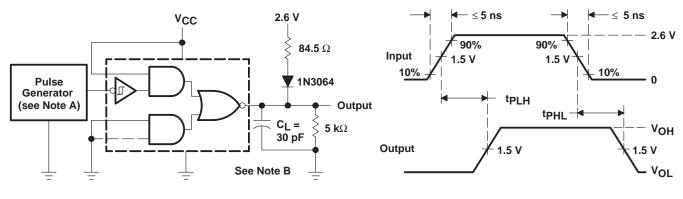
[†] Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 2: The output voltage and current limits are characterized for any appropriate combination of high and low inputs specified by the function table for the desired output.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low-to-high-level output from R input	Soo Eiguro 1		20	30	
^t PHL	Propagation delay time, high-to-low-level output from R input	See Figure 1		20	30	ns

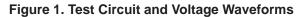
PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

VOLTAGE WAVEFORMS

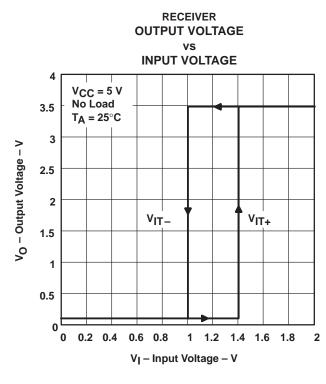
NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50 \ \Omega$, PRR $\leq 5 \ MHz$, duty cycle = 50%. B. C_L includes probe and jig capacitance.



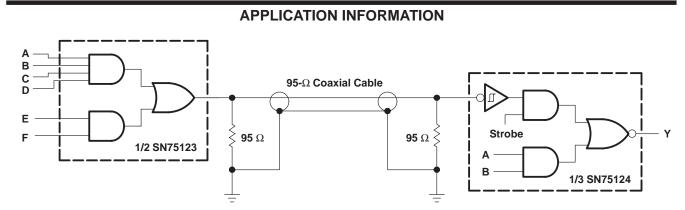


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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN75124D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	Samples Not Available
SN75124N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
SN75124NE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
SN75124NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN75124NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN75124NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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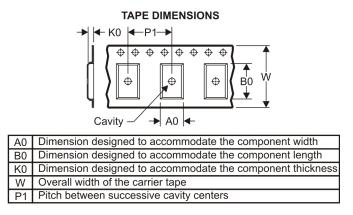
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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions a	are nominal
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Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75124NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75124NSR	SO	NS	16	2000	346.0	346.0	33.0

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



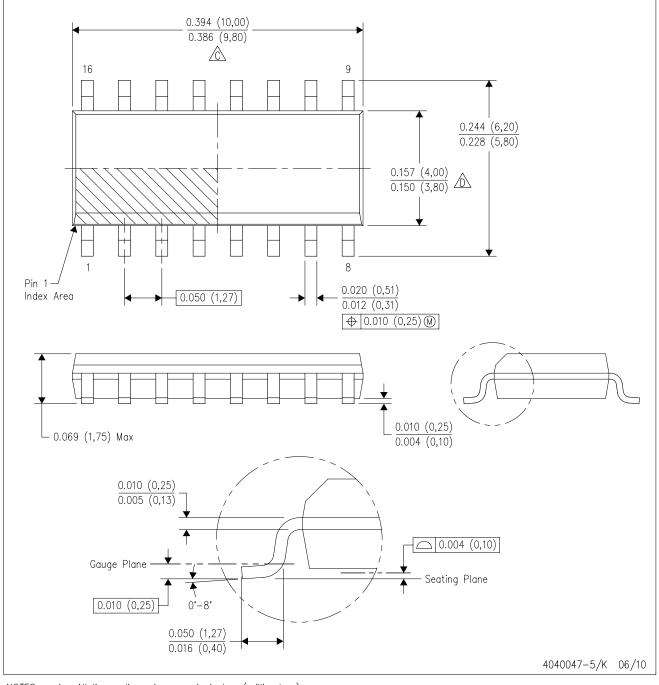
NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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